

**KOPPEL, JACOBS, PATRICK & HEYBL**

AN ASSOCIATION OF PROFESSIONAL LAW CORPORATIONS

RICHARD S. KOPPEL  
 MARVIN E. JACOBS, P.C.  
 STEVEN C. PATRICK  
 JAYE G. HEYBL  
 JAMES K. DAWSON  
 ROBERT T. CONLEY  
 GREG L. MARTINEZ  
 Senior Counsel  
 MICHAEL J. RAM  
 LOUIS A. MOK  
 Patent Agent  
 JOSEPH COMPTON

555 ST. CHARLES DRIVE, SUITE 107  
 THOUSAND OAKS, CALIFORNIA 91360  
 PHONE (805) 373-0060  
 FAX (805) 373-0051

PATENTS  
 TRADEMARKS  
 COPYRIGHTS

September 18, 2003



Mail Stop Patent Application  
 Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Re: MOLDED CHIP FABRICATION METHOD AND APPARATUS  
 Docket No. P0298US-7

Sir:

Transmitted herewith for filing under 35 U.S.C. 111 and 37 CFR 1.53 is the patent application of MICHAEL S. LEUNG, ERIC TARSA and JAMES IBBETSON entitled MOLDED CHIP FABRICATION METHOD AND APPARATUS.

Enclosed are:


35 pages of written description, claims and abstract.  
 11 sheets of drawings plus 2 copies.  
 Declaration and Power of Attorney.

The filing and recording fees have been calculated as shown below:

|                    |          |   |           |            |
|--------------------|----------|---|-----------|------------|
| Basic Fee          |          |   |           | \$750.00   |
| Total Claims       | (37- 20) | x | \$18.00 = | 306.00     |
| Independent Claims | (4- 3 )  | x | \$84.00 = | 84.00      |
| Total Fee:         |          |   |           | \$1,140.00 |

Our Check No. 20639 for **\$1,140.00** to cover the filing and recording fees is enclosed. We authorize the Commissioner to charge (1) payment of any additional filing fees required under 37 CFR §1.16, (2) payment of any patent application processing fees under 37 CFR §1.17 associated with this communication, or (3) payment of any fees that occur during the pendency of this application (and to credit any overpayment) to Deposit Account No. 11-1580. We enclose a duplicate copy of this sheet.

Very truly yours,  
 KOPPEL, JACOBS, PATRICK & HEYBL

  
 Jaye G. Heybl  
 Registration No. 42,661

JGH/mm

Enclosures

M/J4-P0298US-7Transmittal ltr.doc